



Docket No.: M4065.0466/P466  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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In re Patent Application of:  
Neal Rueger

Application No.: 09/938,644

Confirmation No.:

Filed: August 27, 2001

Art Unit: 1765

For: METHOD AND APPARATUS FOR  
MICROMACHINING USING A  
MAGNETIC FIELD AND PLASMA  
ETCHING

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Examiner: T. Mackey

**INFORMATION DISCLOSURE STATEMENT (IDS)**

MS RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Pursuant to 37 C.F.R. §§ 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached PTO/SB/08. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

In accordance with 37 C.F.R. § 1.97(g), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made or that no other material information as defined in 37 C.F.R. § 1.56(a) exists. In accordance with 37 C.F.R. § 1.97(h), the filing of this Information Disclosure statement shall not be construed to be an admission that any patent, publication or other information referred to therein is "prior art" for this invention unless specifically designated as such.

It is submitted that the Information Disclosure Statement is in compliance with 37 C.F.R. §1.98 and the Examiner is respectfully requested to consider the listed references.

The Director is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 04-1073, under Order No. M4065.0466/P466. A duplicate copy of this paper is enclosed.

Dated: March 2, 2004

Respectfully submitted,

By 

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PTO/SB/08a/b (08-03)

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|                                                                                                                                                 |   |    |   | Application Number       | 09/938,644-Conf. #1172 |
|                                                                                                                                                 |   |    |   | Filing Date              | August 27, 2001        |
|                                                                                                                                                 |   |    |   | First Named Inventor     | Neal Rueger            |
|                                                                                                                                                 |   |    |   | Art Unit                 | 1765                   |
|                                                                                                                                                 |   |    |   | Examiner Name            | T. Mackey              |
| Sheet                                                                                                                                           | 1 | of | 2 | Attorney Docket Number   | M4065.0466/P466        |

| U.S. PATENT DOCUMENTS |                          |                                          |                                |                                                    |                                                                                 |
|-----------------------|--------------------------|------------------------------------------|--------------------------------|----------------------------------------------------|---------------------------------------------------------------------------------|
| Examiner<br>Initials* | Cite<br>No. <sup>1</sup> | Document Number                          | Publication Date<br>MM-DD-YYYY | Name of Patentee or<br>Applicant of Cited Document | Pages, Columns, Lines, Where<br>Relevant Passages or Relevant<br>Figures Appear |
|                       |                          | Number-Kind Code <sup>2</sup> (if known) |                                |                                                    |                                                                                 |
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|                          |                          | Country Code <sup>3</sup> | Number <sup>4</sup> -Kind Code <sup>5</sup> (if known) |                                   |                                                    |                                                                                 |
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| NON PATENT LITERATURE DOCUMENTS |                          |                                                                                                                                                                                                                                                                 |                |
|---------------------------------|--------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|
| Examiner<br>Initials*           | Cite<br>No. <sup>1</sup> | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. | T <sup>2</sup> |
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| Sheet                                                                                                                                                  | 2 | of | 2 | Attorney Docket Number   | M4065.0466/P466        |

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|-----------------------|--|--------------------|--|
| Examiner<br>Signature |  | Date<br>Considered |  |
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